TOSHIBA Photocoupler GaAs Ired & Photo-Triac

# **TLP3064(S)**

Office Machine Household Use Equipment Triac Driver Solid State Relay

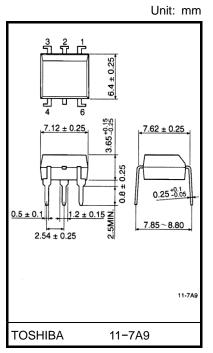
The TOSHIBA TLP3064(S) consists of a zero voltage crossing turn—on photo—triac optically coupled to a GaAlAs infrared emitting diode in a six lead plastic DIP package.

- Peak off-state voltage: 600V(min.)
- Trigger LED current: 3mA(max.)
- On-state current: 100mA(max.)
- Isolation voltage: 5000Vrms(min.)
- UL approved: UL1577, File No.E67349
- cUL approved :CSA Component Acceptance Service No. 5A, File No.E67349
- Option (D4) VDE approved:
   DIN EN60747-5-5, EN60065, EN60950-1 (Note 1)
   EN62368-1 (Pending) (Note 1)

(Note 1): When a EN60747-5-5 approved type is needed, please designate "Option(D4)"

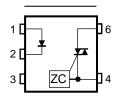
7.62mm pitch
standard type
Creepage distance: 7.0mm(min.)
Clearance: 7.0mm(min.)
Insulation thickness: 0.5mm(min.)

7.62mm pitch
(LF2)type
8.0mm(min.)
8.0mm(min.)



Weight: 0.39 g(typ.)

### Pin Configurations(top view)



- 1: ANODE
- 2: CATHODE
- 3: N.C.
- 4: TERMINAL 1
- 6: TERMINAL 2

(ZC: Zero-cross Circuit)



#### **Absolute Maximum Ratings (Ta = 25°C)**

	Characteristic		Symbol Rating		Unit	
	Forward current		lF	30	mA	
	Forward current derating (Ta ≥	ΔI <sub>F</sub> / °C	-0.3	mA / °C		
	Peak forward current (100μs pu	lFP	1	А		
LED	Reverse voltage	verse voltage		5	V	
	Forward current Forward current derating (Ta $\geq$ 25°C)  Peak forward current (100 $\mu$ s pulse, 100pps)  Reverse voltage  Input power dissipation  Input power dissipation derating (Ta $\geq$ 25°C)  Junction temperature  Off-state output terminal voltage  On-state RMS current  Ta=25°C  Ta=70°C  IT(RMS  Ta=25°C)  Peak on-state current derating (Ta $\geq$ 25°C)  Peak on-state current (100 $\mu$ s pulse, 120pps)  ITP  Peak nonrepetitive surge current (PW=10ms, DC=10%)  Output power dissipation  Output power dissipation derating (Ta $\geq$ 25°C)  Junction temperature  ge temperature range  ating temperature range  Topr  Tsol	PD	100	mW		
	Input power dissipation derating	ΔP <sub>D</sub> /°C	-1.0	mW/°C		
	Junction temperature	Tj	125	°C		
	Off-state output terminal voltag	V <sub>DRM</sub>	600	V		
	On-state RMS current	Ta=25°C	IT(DMO)	100	mA	
		Ta=70°C	T(RMS)	50	IIIA	
'n		ΔI <sub>T</sub> / °C	-1.1	mA / °C		
Detector	Peak on-state current (100μs p	ITP	2	Α		
		I <sub>TSM</sub>	1.2	А		
	Output power dissipation	PO	300	mW		
	Output power dissipation derati	⊿PO/°C	-3.0	mW/°C		
	Junction temperature	Tj	115	°C		
Storag	Storage temperature range			−55 to 150	°C	
Operat	ting temperature range	range T <sub>opr</sub> -40 to 100			°C	
Lead s	oldering temperature (10s)		T <sub>sol</sub> 260			
	on voltage min., R.H. ≤ 60%)	(Note 1)	BVs	5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device=Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	VAC	_	_	240	Vac
Forward current	lF	4.5	6	7.5	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	T <sub>opr</sub>	-10	1	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

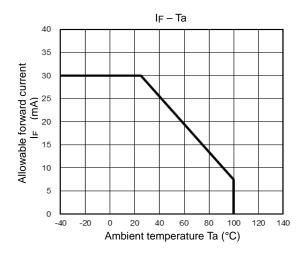
## Individual Electrical Characteristics (Ta = 25°C)

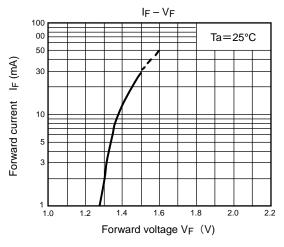
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	VF	I <sub>F</sub> =10mA	1.2	1.4	1.7	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =3 V	_	_	10	μА
	Capacitance	СТ	V=0 V, f=1MHz	_	30	_	pF
Detector	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> =600V	_	10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> =100mA	_	_	3.0	٧
	Holding current	lн	_	_	0.6	_	mA
	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> =240rms Ta=85°C	200	500	_	V / μs
	Critical rate of rise of commutating voltage	dv / dt(c)	V <sub>in</sub> =60Vrms I <sub>T</sub> =15mArms	-	0.2	_	V / μs

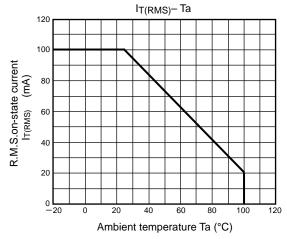
## **Coupled Electrical Characteristics (Ta = 25°C)**

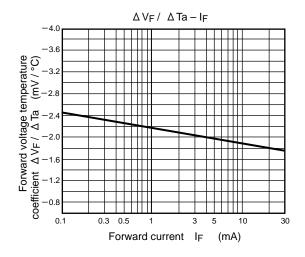
Characteristics	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	IFT	V <sub>T</sub> =6V, resistive load	_	_	3	mA
Inhibit voltage	VIH	IF=rated IFT	_	_	50	V
Leakage in inhibited state	lін	I <sub>F</sub> =rated I <sub>F</sub> T V <sub>T</sub> =rated V <sub>DRM</sub>	_	_	600	μА
Capacitance input to output	Cs	V <sub>S</sub> =0 V, f=1MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> =500V, R.H. ≤ 60%	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
	BVs	AC, 1 minute	5000	_	_	Vrms
Isolation voltage		AC, 1 second, in oil	_	10000	_	
		DC, 1 minute, in oil	_	10000	_	Vdc

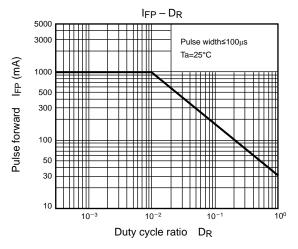
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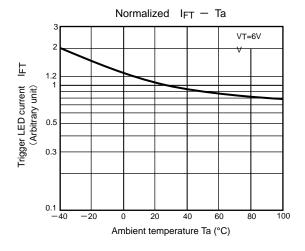


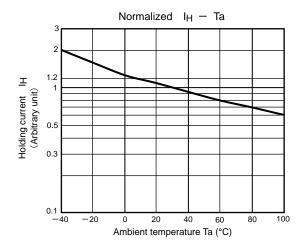


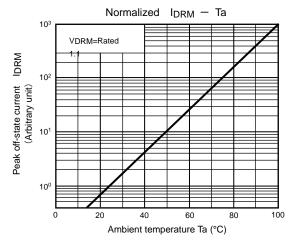


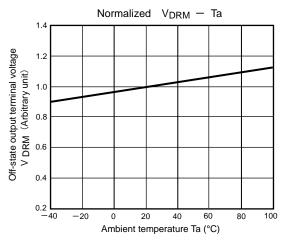


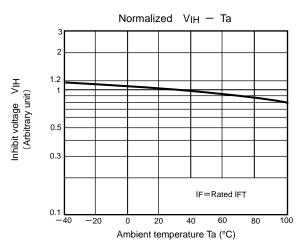
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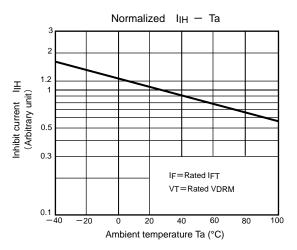












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